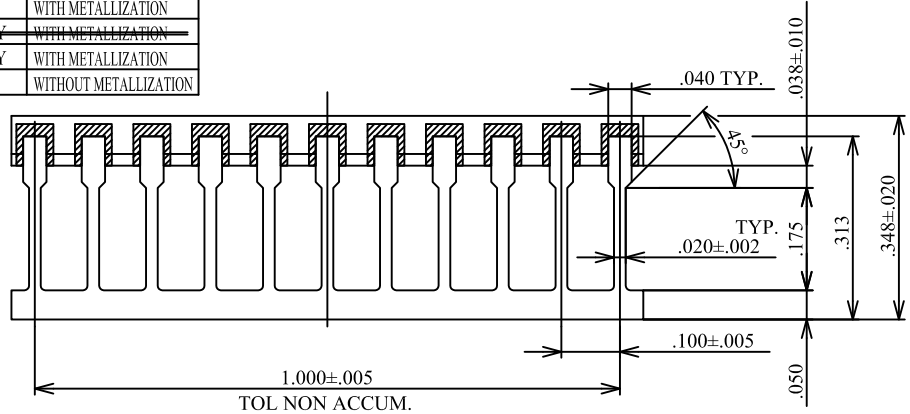


PART No.	I.D MARK	LEAD TIED DOWN	NOTCH AREA METALLIZED
01	0	NIL	WITH METALLIZATION
<del>02</del>	<del>▽</del>	<del>No.1 ONLY</del>	<del>WITH METALLIZATION</del>
03	△△	No.6 ONLY	WITH METALLIZATION
04	0	NIL	WITHOUT METALLIZATION

NOTES

1. PLATING THICKNESS TO BE PER CUSTOMER'S SPECIFICATION.
2. SEAL AREA TO BE METALLIZED.
3. DIE ATTACH AREA TO BE METALLIZED.
4. LEAD RESISTANCE : 0.30 OHM MAX.
5. WIRE BOND PAD CONNECTED TO CORRESPONDED OUTER LEADS.
6. MISALIGNMENT OF METALLIZATION PATTERN IN CAVITY SHALL BE ACCEPTED DUE TO LAYER MISALIGNMENT.



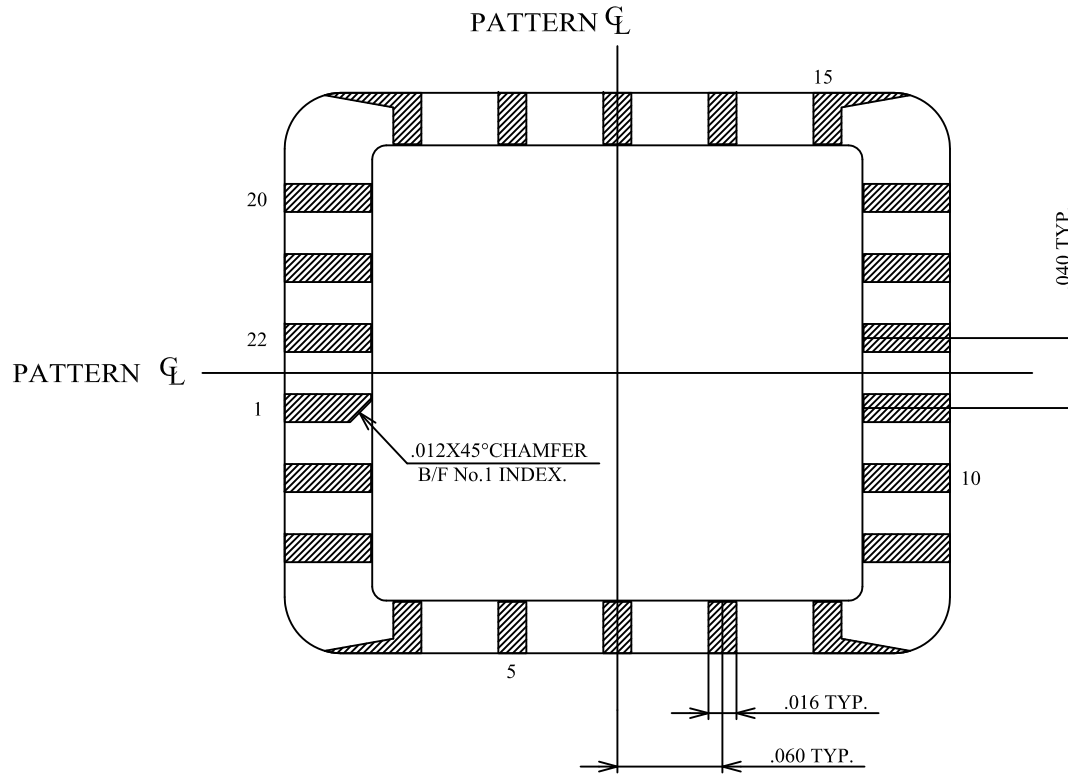
SB022I409-4	S=0 D=0
SB022I409-3	S=0 D=6
<del>SB022I409-2</del>	<del>S=0 D=1</del>
SB022I409-1	S=0 D=0

MODIFICATION	DESCRIPTION	DATE	DRAWN	CHECKED	APPROVED
△	ADDED : PART No.4 , NOTE 5,6 , DELETED : VENDOR'S OPTION , PART No.02	MAR.24'10	T.M/Y.H	H.M/S.NI	Y.F
	ADDED:SHEET 2/2				
△	REDRAWN: CONVERTED CAD DATA.	AUG.9'99	Y.T	H.S/S.K	H.SA
	CHANGED	DATE	DRAWN	CHECKED	APPROVED

NAME	22 LEAD SIDE BRAZED PACKAGE	TOLERANCE	UNLESS OTHERWISE SPECIFIED
SCALE	5 / 1	±.005	THIRD ANGLE PROJECTION
MATERIAL	AS INDICATED		
<b>KYOCERA</b>	KYOCERA CORPORATION KYOTO JAPAN		

DRAWN	CHECKED	APPROVED	DATE
S.S	K.M		OCT.3'78
DRAWING NO.			SHEET
KD-S78409-D			1 / 2





BONDING PATTERN

MODIFICATION						NAME 22 LEAD SIDE BRAZED PACKAGE	TOLERANCE UNLESS OTHERWISE SPECIFIED	DRAWN Y.T	CHECKED H.S/S.K	APPROVED H.SA	DATE AUG.9.99
						SCALE 15/1	MATERIAL				
							THIRD ANGLE PROJECTION				
	△	ADDED: THIS SHEET	AUG.9.99	Y.T	H.S/S.K	H.SA	<b>KYOCERA</b>	KYOCERA CORPORATION KYOTO JAPAN	DRAWING NO. KD-S78409-D		SHEET 2/2
	CHANGED	DATE	DRAWN	CHECKED	APPROVED						



